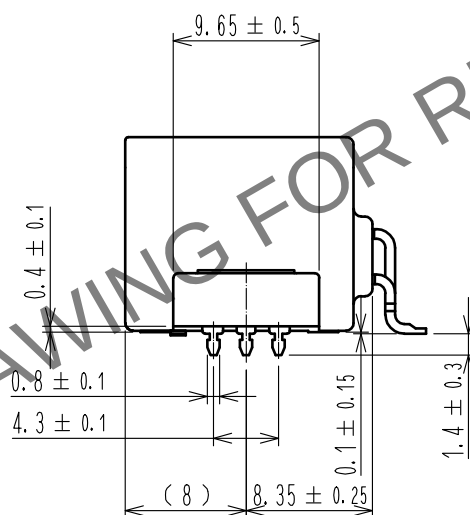
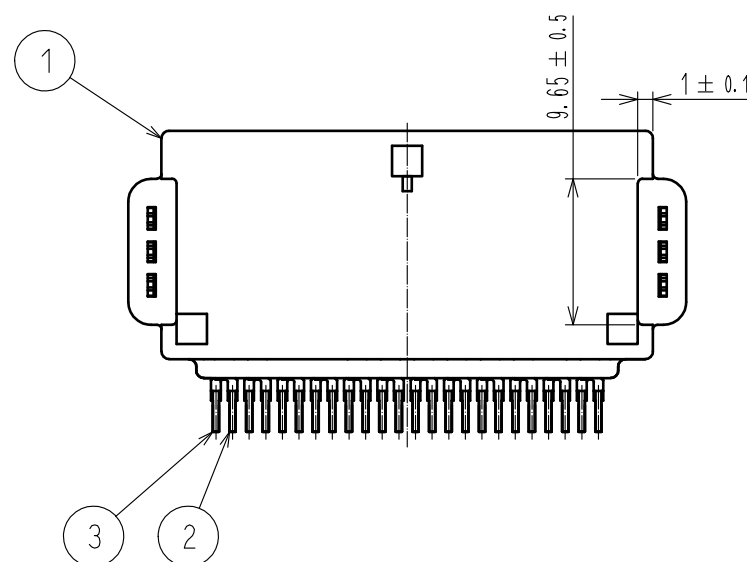
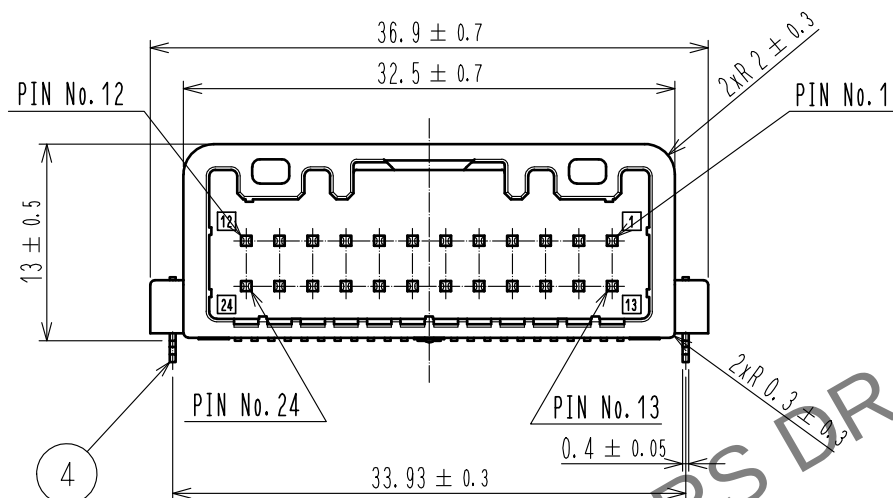
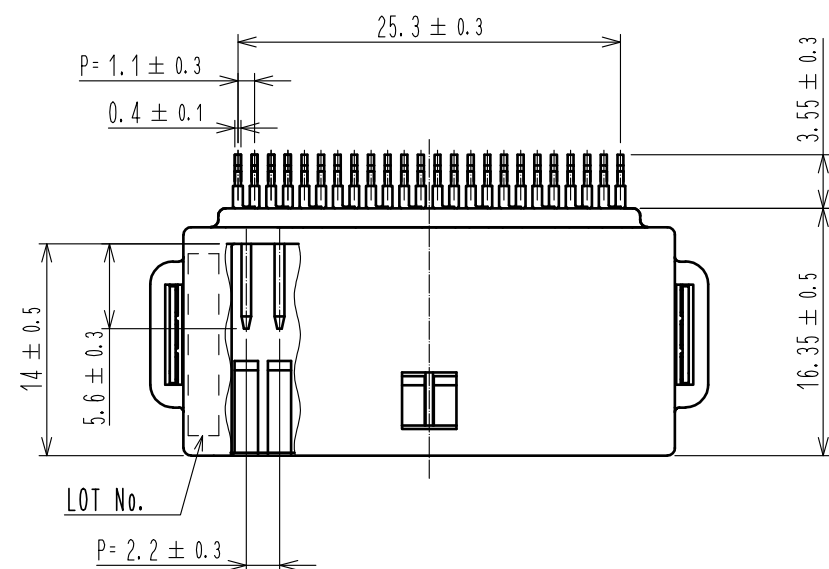


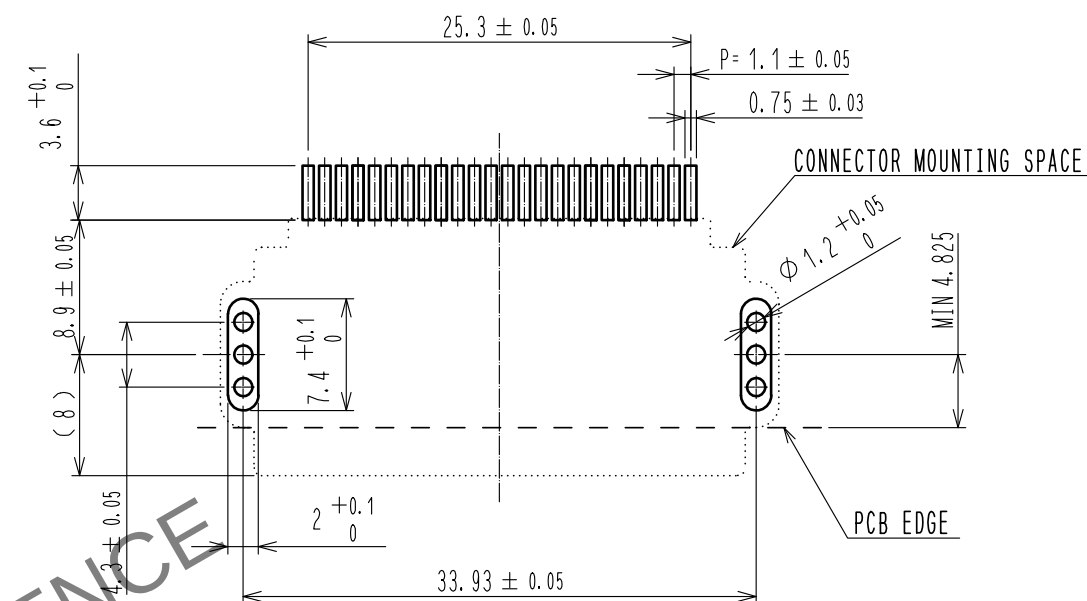
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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

ELV, RoHS COMPLIANT



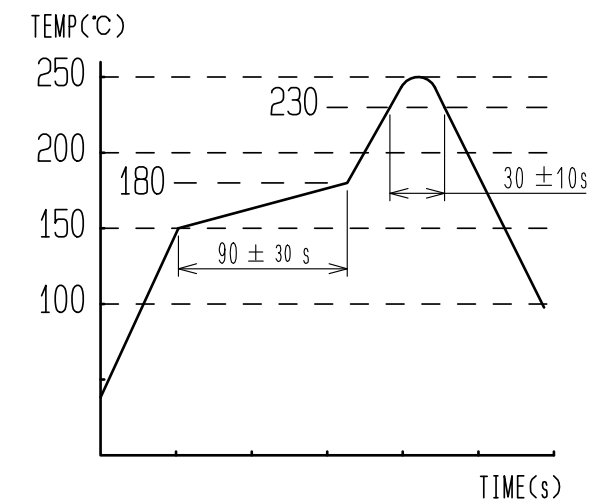
PIN ASSIGNMENT

12 11 10 9 8 7 6 5 4 3 2 1
24 23 22 21 20 19 18 17 16 15 14 13

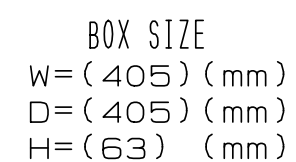


RECOMMENDED PCB PATTERN

- NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
USED REFLOW SYSTEM : IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C
60~120s
2. TEMPERATURE FOR SOLDERING IRON : 280~300°C WITHIN 2s
3. CO-PLANARITY SHALL BE 0.1mm MAX.
4. RECOMMENDED PCB THICKNESS IS 1.6mm.
5. RECOMMENDED SOLDER THICKNESS IS 0.15mm.



3	BRASS	TIN PLATED T=0.64	6	PET	
2	BRASS	TIN PLATED T=0.64	5	PS	
1	PPS	BLACK	4	BRASS	TIN PLATED T=0.4
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
		APPROVED : AR. SHIRAI	16.09.09	DRAWING NO.	EDC-358752-99-00
		CHECKED : HS. OZAWA	16.09.09	PART NO.	GT25H2-24DP-2. 2H(99)
		DESIGNED : TK. SHISHIKURA	16.09.09	CODE NO.	CL775-0081-2-99
		DRAWN : TK. SHISHIKURA	16.09.09		



HRS	DRAWING NO.	EDC-358752-99-00	
	PART NO.	GT25H2-24DP-2. 2H<99>	
	CODE NO.	CL775-0081-2-99	 